

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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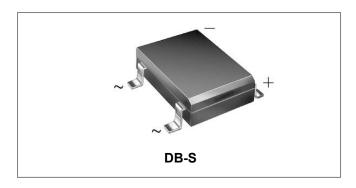








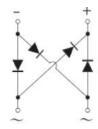
DB151S THRU DB157S SINGLE-PHASE GLASS PASSIVATED SILICON BRIDGE RECTIFIERS



Features

- Glass passivated die construction
- Low forward voltage drop
- · High current capability
- High surge current capability
- Designed for surface mount application
- Plastic material-UL flammability 94V-0
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- · Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

- Case: DB-S, molded plastic
- Terminals: plated leads solderable per MIL-STD-202, Method 208
- Polarity: as marked on case
- Mounting position: Any
- Lead Free: For RoHS / Lead Free Version,

Maximum Ratings @T_A=25°C unless otherwise specified

Single Phase half wave 60Hz, resistive or inductive load. For capacitive load current derate by 20%.

Characteristic	Symbol	DB 151S	DB 152S	DB 153S	DB 154S	DB 155S	DB 156S	DB 157S	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Average Forward Output Current (Note 1) @ T _C =100°C	I _{F(AV)}	1.5				А			
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	55				А			
I ² t Rating for Fusing (t < 8.3ms)	I²t	12.6					A ² s		

- China Germany Korea Singapore United States
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Electrical Characteristics @T_A=25°C unless otherwise specified

Characteristic	Symbol	DB 151S	DB 152S	DB 153S	DB 154S	DB 155S	DB 156S	DB 157S	Units
Maximum Forward Voltage Drop* per Bridge Element @I _F =1.5A, T _J =25°C	V _F	1.0			V				
Peak Reverse Current* @T _A = 25°C At Rated DC Blocking Voltage* @T _A = 125°C	I _R	5 200			μA				
Typical Junction Capacitance (Note 2)	С	25			pF				

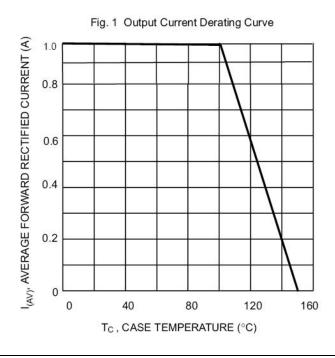
^{*} Pulse width < 300 µs, duty cycle < 2%

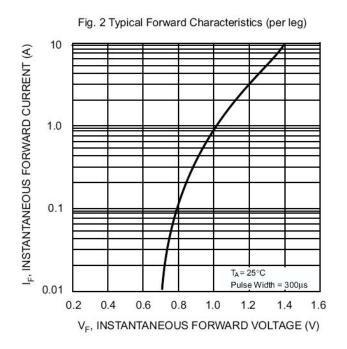
Thermal-Mechanical Specifications @TA=25°C unless otherwise specified

Characteristic	Symbol	DB 151S	DB 152S	DB 153S	DB 154S	DB 155S	DB 156S	DB 157S	Units
Typical Thermal Resistance Junction to Ambient	R _{0JA}	40			°C/W				
Typical Thermal Resistance Junction to Lead	R _{0JL}	. 15			°C/W				
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 to + 150			°C				

Note: 1. Mounted on glass epoxy PC board with 1.3mm² solder pad.

Ratings and Characteristics Curves





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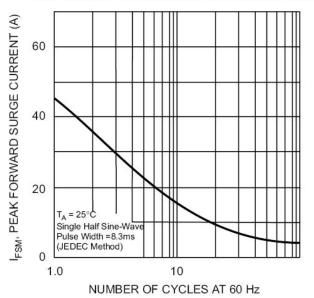
^{2.} Measured at 1.0 MHZ and applied reverse voltage of 4.0 VDC

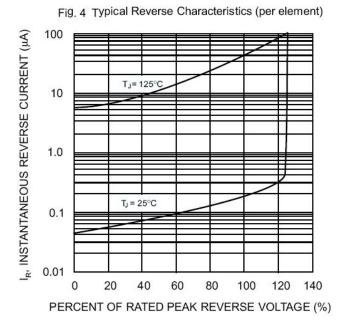




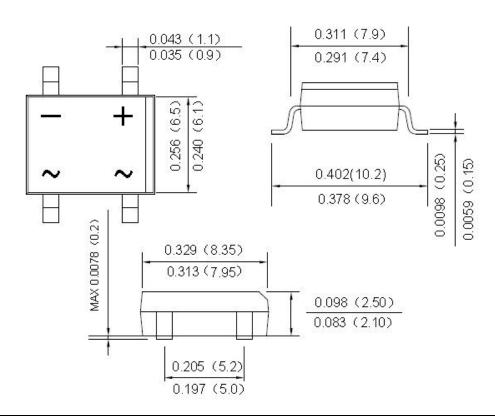


Fig. 3 Maximum Peak Forward Surge Current (per leg)





Mechanical Dimensions DB-S(Inches/Millimeters)



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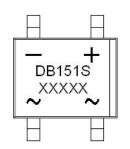


Ordering Information

Device	Package	Plating	Shipping
DB151S THRU DB157S	DB-S (Pb-Free)	Pure Sn	1500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



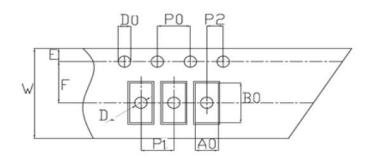
Where XXXXX is YYWWL

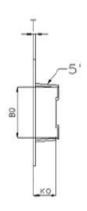
DB151S = Type Number
YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

Carrier Tape Specification DB-S





SYMBOL	Millimeters					
STWBOL	Min.	Max.				
A0	8.65	8.95				
В0	10.31	10.51				
D0	1.50	1.60				
D1	1.40	1.60				
P0	3.90	4.10				
P1	11.90	12.10				
P2	1.90	2.10				
Е	1.65	1.85				
K0	3.21	3.41				
F	7.40	7.60				
W	15.70	16.30				
Т	0.30	0.40				
10P0	39.80	40.20				



DB151S THRU DB157S

Technical Data Data Sheet N1476, Rev. C





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